

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	14755	((tab near9 (chip or device or circuit)) and (seal\$4 or encapsula\$4) same (chip or device or circuit))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/18 13:23
S2	6014	((tab near9 semiconductor))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/02 10:09
S3	2071	((tab near9 semiconductor) same mount\$4)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/02 10:12
S4	633	((tab near9 semiconductor) same mount\$4 and ((seal\$4 or encapsul\$8) near9 chip))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/02 10:25
S5	451	((tab near9 semiconductor) same mount\$4 and ((seal\$4 or encapsul\$8) near9 chip) and (lead\$4 near9 mount \$4))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/02 10:31
S6	86	((tab near9 semiconductor) same mount\$4 and ((seal\$4 or encapsul\$8) near9 chip) and (lead\$4 near9 mount \$4) and wir\$4 and QFN)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/02 10:38
S7	80	((tab near9 semiconductor) same mount\$4 and ((seal\$4 or encapsul\$8) near9 chip) and (lead\$4 near9 mount \$4) and wir\$4 and QFN and electrode)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/02 11:11
S8	9	((tab near9 semiconductor) same mount\$4 and ((seal\$4 or encapsul\$8) near9 chip) and (lead\$4 near9 mount \$4) and wir\$4 and QFN and electrode and notch)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/02 11:12

S9	54	(tab near9 semiconductor) same mount\$4 and ((seal\$4 or encapsul\$8) near9 chip) and (lead\$4 near9 mount \$4) and wir\$4 and QFN and electrode and (notch or slit or deform\$8)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/02 11:59
S10	7	(tab near9 semiconductor) same mount\$4 and ((seal\$4 or encapsul\$8) near9 chip) and (lead\$4 near9 mount \$4) and wir\$4 and QFN and electrode and (notch or slit or deform\$8) and (257/678.ccls.)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/02 12:07
S11	9	(tab near9 semiconductor) same mount\$4 and ((seal\$4 or encapsul\$8) near9 chip) and (lead\$4 near9 mount \$4) and wir\$4 and QFN and electrode and (notch or slit or deform\$8).clm.	US-PGPUB	OR	ON	2008/12/02 12:08
S12	17	(tab near9 semiconductor) same mount\$4 and ((seal\$4 or encapsul\$8) near9 chip) and (lead\$4 near9 mount \$4) and wir\$4 and QFN and electrode and (notch or slit or deform\$8) and (438/106,112,123,126,127.ccls.)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/02 12:57

12/ 3/ 08 9:22:04 AM

C:\ Documents and Settings\ mharrison1\ My Documents\ EAST\ workspaces\ 10519785.wsp